

FINE MADE MICROELECTRONICS GROUP CO., LTD.

FM1660文件编号: S&CIC2061)

High power SP10T Switch with MIPI for TX/RX

Features

- Excellent insertion loss: 0.85dB @2.7GHz
- P0.1dB @ 36dBm
- Multi-Band operation 700MHz to 2700MHz
- RFFE 2.0 control interface
- Compact 2.4mm x 2.4mm in QFN-20 package
- No DC blocking capacitors required (unless external DC is applied to the RF ports)

Applications

- 2G/3G/4G antenna transmitting and receiving
- Cellular modems and USB Devices

Description

The FM1660 is a low loss, high isolation high power SP10T switch for antenna transmitting and receiving. The FM1660 is compatible with MIPI 2.0 control, which is a key requirement for many cellular transceivers. This part is packaged in a compact 2.4mm x 2.4mm, 20-pin, QFN package which allows for a small solution size with no need for external DC blocking capacitors (when no external DC is applied to the device ports).

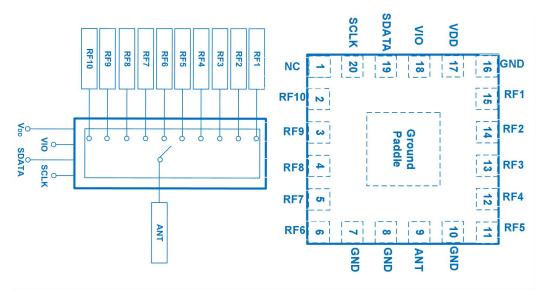


Figure 1. FM1660 Functional Block Diagram and Pinout(Top View)



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Application Circuit

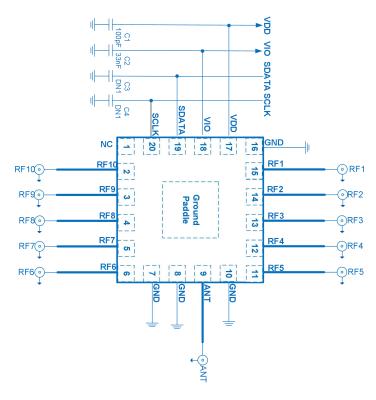


Figure 2. FM1660 Evaluation Board Schematic

Table 1 Pin Descriptions

Pin No.	Name	Description	Pin No.	Name	Description		
1	NC	Not Connect	11	RF5	RF port5		
2	RF10	RF port10	12	RF4	RF port4		
3	RF9	RF port 9	13	RF3	RF port3		
4	RF8	RF port8	14	RF2	RF port2		
5	RF7	RF port7	15	RF1	RF port1		
6	RF6	RF port6	16	GND	Ground		
7	GND	Ground	Ground 17 VDD P		Power supply		
8	GND	Ground	18	VIO	Supply voltage for MIPI		
9	ANT	Antenna port	19	SDATA	MIPI data input/output		
10	GND	Ground	20	SCLK	MIPI clock		
Ground Paddle	GND	Ground					

Notice: Bottom ground paddles must be connected to ground.



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Truth Table

Table 2 Truth Table

State	Mode	Register_0								
		D7	D6	D5	D4	D3	D2	D1	D0	
1	ISO	x	0	0	0	0	0	0	0	
2	RF1 on	x	0	0	0	0	0	1	0	
3	RF2 on	x	0	0	0	1	0	1	0	
4	RF3 on	x	0	0	0	1	1	1	0	
5	RF4 on	X	0	0	0	1	0	1	1	
6	RF5 on	x	0	0	0	0	0	0	1	
7	RF6 on	x	0	0	0	1	0	0	1	
8	RF7 on	x	0	0	0	0	1	1	0	
9	RF8 on	х	0	0	0	0	1	0	0	
10	RF9 on	х	0	0	0	1	1	0	0	
11	RF10 on	х	0	0	0	1	0	0	0	

Absolute Maximum Ratings

Table 3 Absolute Maximum ratings

Parameters	Symbol	Minimum	Maximum	Units
Supply voltage	VDD	+2.5	+4.8	V
Supply voltage for MIPI	Vio	+1.4	+2.0	V
MIPI Control voltage (SDATA, SCLK)	VCTL	0	+2.0	V
RF input power (RF1 to RF10)	PIN		+36	dBm
Operating temperature	ТОР	-20	+85	c
Storage temperature	TSTG	-40	+125	င
Human body model (HBM), Class 1C	ESD_HBM		1000	V
Charged device model (CDM), Class III	ESD_CDM		1000	V

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device



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Electrical Specifications

Table 4 Electrical Specifications

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
DC Specifications						
Supply voltage	VDD		2.5	2.8	4.2	V
Supply current	IDD			80	100	uA
VIO supply voltage	VIO		1.65	1.8	1.95	V
VIO Supply current	IIO			5	10	uA
SDATA, SCLK control voltage: High	VCTL_H		0.8* VIO	VIO	1.95	V
Low	VCTL_L		0	0	0.3	V
		From 50% of final VCTL				
Switching Speed		voltage to 10%/90% of		2	5	uS
		final RF power				
RF Specifications						
Insertion loss (ANT pin to		0.1 to 1.0 GHz		0.55		
RF1/2/3/4/5/6/7/8/9/10 pins)	IL	1.0 to 2.0 GHz		0.70		dB
iti 1/2/3/4/3/0/7/0/3/10 pilis)		2.0 to 2.7 GHz		0.85		
Isolation (ANT pin to		0.1 to 1.0 GHz	30	35		
RF1/2/3/4/5/6/7/8/9/10 pins)	Iso	1.0 to 2.0 GHz	20	25		dB
KF 1/2/3/4/3/6/7/6/3/10 pills)		2.0 to 2.7 GHz	19	21		
0.1 dB Compression Point (ANT pin to RF1/2/3/4/5/6/7/8/9/10 pins)	P0.1dB	0.7 GHz to 3.0 GHz		+36		dBm
		F0=900MHz @ 35dBm		-50	-45	
2nd Harmonic	2F0	F0=900MHz @ 26dBm		-65	-60	
	 -	F0=900MHz @ 35dBm		-45	-40	dBm
3rd Harmonic	3F ₀	F0=900MHz @ 26dBm		-70	-65	



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MIPI Read and Write Timing

MIPI supports the following Command Sequences:

- · Register Write
- Register_0 Write
- · Register Read

Figures 3 and 4 provide the timing diagrams for register write commands and read commands, respectively. Figure 5 shows the Register 0 Write Command Sequence. Refer to the MIPI Alliance Specification for RF Front-End Control Interface (RFFE), v1.10 (26 July 2011) for additional information on MIPI USID programming sequences and MIPI bus specifications.

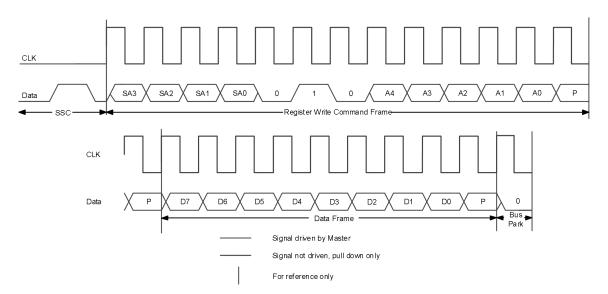


Figure 4 Register Write Command Sequence

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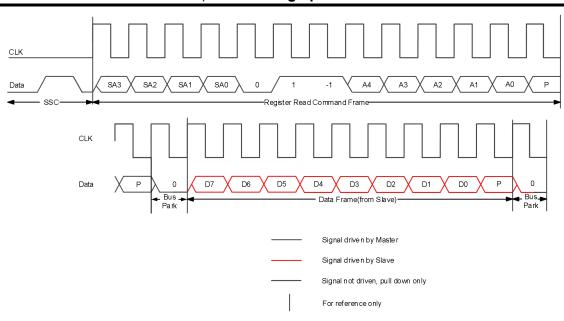


Figure 5 Register Read Command Sequence

In the timing figures, SA[3:0] is slave address. A[4:0] is register address. D[7:0] is data. "P" is odd parity bit.



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Register 0 Write Command Sequence

Figure shows the Register 0 Write Command Sequence. The Command Sequence starts with an SSC, followed by the Register 0 Write Command Frame containing the Slave address, a logic one, and a seven bit word to be written to Register 0. The Command Sequence ends with a Bus Park Cycle.

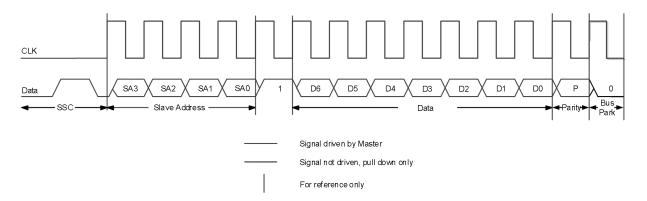


Figure 6 Register 0 Write Command Sequence



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Register definition

Table 5 Register definition table

Register Address	Register Name	Data Bits	R/W	Function	Description	Default	BROADC AST_ID	Trigger
-							support	support
0x00	REGISTER_0	7:0	R/W	RF Control	Register_0 truth Table: Table 2	0x00	No	Yes
0x001B	GROUP_SID	7:4	R	RESERVED		0x0	No	No
		3:0	R/W	GSID	Group Slave ID	0x0	No	No
0x001C	PM_TRIG	7:6	R/W	PWR_MODE	00: Normal Operation (ACTIVE)	0b10	Yes	No
					01: Reset all registers to default settings			
					(STARTUP)			
					10: Low power (LOW POWER)			
					11: Reserved			
					Note: Write PWR_MODE=2'h1 will reset all			
					register, and puts the device into STARTUP			
					state.			
		5	R/W	Trigger_Mask_2	If this bit is set, trigger 2 is disabled	0	No	No
		4	R/W	Trigger_Mask_1	If this bit is set, trigger 1 is disabled	0	No	No
		3	R/W	Trigger_Mask_0	If this bit is set, trigger 0 is disabled	0	No	No
					Note: When all triggers are disabled,			
					writing to a register that is associated with			
					trigger 0, 1, or 2, causes the data to go			
					directly to the destination register.			
		2	w	Trigger_2	A write of a one to this bit loads trigger	0	Yes	No
				00 _	2's registers			
		1	w	Trigger_1	A write of a one to this bit loads trigger 1's	0	Yes	No
				33	registers			
		0	w	Trigger_0	A write of a one to this bit loads trigger 0's	0	Yes	No
					registers			
					Note: Trigger processed immediately then			
					cleared. Trigger 0, 1, and 2 will always read			
					as 0.			
0x001D	PRODUCT_ID	7:0	R	PRODUCT_ID	Product Number	0x45	No	No
0x001E	MANUFACTU	7:0	R	MANUFACTUR	Lower eight bits of MIPI registered	0x78	No	No
	RER_ID			ER_ID[7:0]	Manufacturer ID			
		7:4	R	MANUFACTUR	Upper two bits of MIPI registered	0x4	No	No
0x001F	MAN_USID			ER_ID[9:8]	Manufacturer ID			
		3:0	R/W	USID	USID of the device.	0xA	No	No



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Power ON and OFF sequence

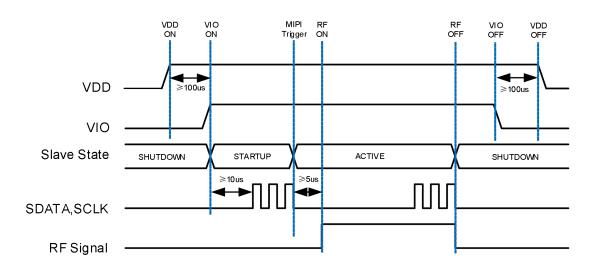
Here is the recommendation about power-on/off sequence in order to avoid damaging the device.

Power ON

- 1) Apply voltage supply VDD
- 2) Apply logic supply VIO
- 3) Wait 10µs or greater and then apply MIPI bus signals SCLK and SDATA
- 4) Wait 5µs or greater after MIPI bus goes idle and then apply the RF Signal

Power OFF

- 1) Remove the RF Signal
- 2) Remove MIPI bus SCLK and SDATA
- 3) Remove logic supply VIO
- 4) Remove voltage supply VDD



Note: VIO can be applied to the device before VDD or removed after VDD.

It is important to wait 10 μ s after VIO & VDD are applied before sending SDATA to ensure correction data transmission. The minimum time between a power up and power down sequence (and vice versa) is \geq 100 μ s.



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Reflow Chart

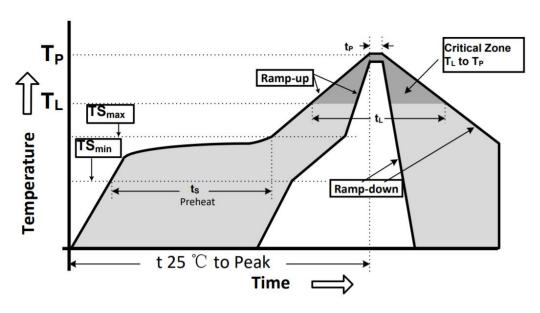


Figure 5 Recommended Lead-Free Reflow Profile

Table 6 Reflow Chart Parameters

Reflow Profile	Parameter				
Preheat Temperature(TS _{MIN} to TS _{MAX})	150℃ to 200℃				
Preheat Time(t _s)	60 to 180 Seconds				
Ramp-Up Rate(TS _{MAX} to T _P)	3℃/s MAX				
Time Above T _L 217℃(t _L)	60 to 150 Seconds				
Peak Temperature (T _P)	260℃				
Time within 5℃ of Peak Temperature(t _P)	20 to 40 Seconds				
Ramp-Down Rate(TS _{MAX} to T _P)	6℃/s MAX				
Time for 25℃ to Peak Temperature(t _{25-TP})	8 Minutes MAX				

ESD Sensitivity

Integrated circuits are ESD sensitive and can be damaged by static electric charge. Proper ESD protection techniques should be applied when devices are operating.

RoHS Compliant

This product does not contain lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE), and is considered RoHS compliant.